



Data Sheet

Customer:	
Part No:	CL-SFC615DBW-6.5K-90CRI
Sample No:	
Description:	5630 White SMD
Item No:	

Customer					
Check	Check Inspection Approval Date				





Features:

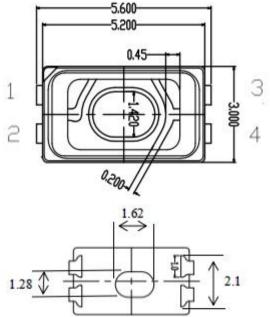
- . Reflow Solderable
- . High Luminous Intensity and Low Power Dissipation
- . Good Reliability and Long Life
- . Complied With RoHS Directive

Technical Data Sheet

This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard.

Applications

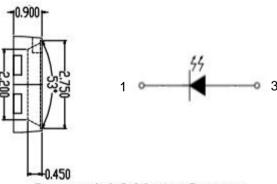
- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use



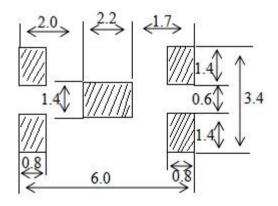
Notes:

- 1 . All dimension units are millimeters.
- 2. All dimension tolerance is ±0.2mm unless otherwise noted.





Recommended Soldering Pattern: (Units: mm)



Page:1 of 8 REV NO: A/1





Selection Guide

Part No.	Dice L	Lens Type	Luminous Flux(Lm) @150mA			Viewing Angle
			Min	Тур	Max	201/2
CL-SFC615DBW-6.5K-90CRI	Blue (InGaN)	Yellow Diffused	57	59	61	120

Note:

- 1.201/2 is the angle from optical centerline where the luminous intensity is 201/2 the optical centerline value.
- 2. The above luminous intensity measurement allowance tolerance $\pm 10\%$

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max	Units	test conditions
Forward Voltage	VF	2.8		3.4	V	IF=150mA
Reverse Current	IR			10	uA	VR = 5V
Color Rndering Index	CRI	80			/	IF=150mA
Color Temperature	Тс	6200		6800	K	IF=150mA

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	500	mW
DC Forward Current	IF	150	mA
Peak Forward Current [1]	IFP	300	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

Note:

- 1. 1/10 Dut cycle,0.1ms pulse width.
- 2. The above forward voltage measurement allowance tolerance $\pm 0.1 V$.

REV NO: A/1 Page :2 of 8





Production List

Model:	Luminous flux:(LM)	Voltage: (V)
CL-SFC615DBW-6.5K-90CRI	57-61	2.8-3.4

Bin Range of FLUX

BIN	Code	min	max	Unit
LM	L1	57	59	lm
	L2	59	61	lm

Bin Range of Forward Voltage

BIN	Code	min	max	Unit
VF	V1	2.8	2.9	V
	V2	2.9	3.0	V
	V3	3.1	3.2	V
	V4	3.2	3.3	V
	V5	3.3	3.4	V

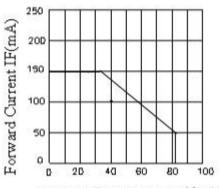
REV NO: A/1 Page :3 of 8



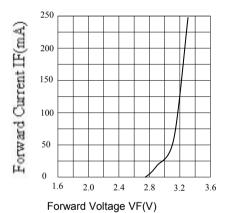


Typical optical characteristics curves

Ambient Temperature VS. Forward Current

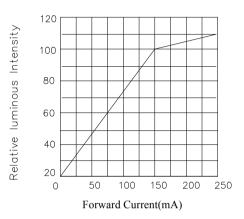


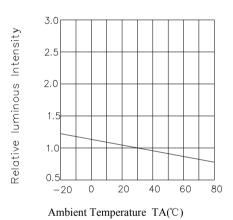
Ambient Temperature (° C)

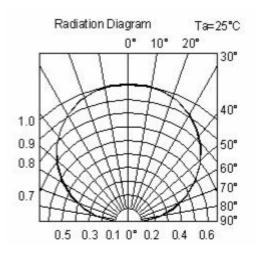


380.0 420.0 460.0 500.0 540.0 580.0 620.0 660.0 700.0 740.0 780.0

Wavelength λ (nm)





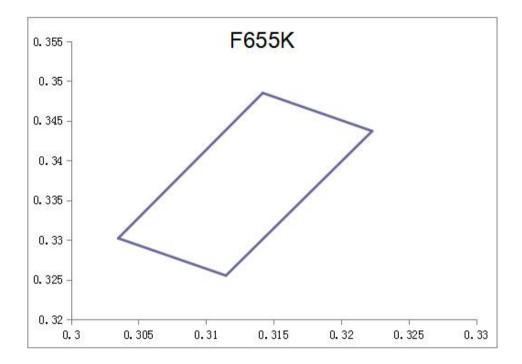


REV NO: A/1 Page :4 of 8





Bin Color



	0.3142	0.3485
	0.3223	0.3437
F655	0.31147	0.3255
	0.3035	0.3302
	0.3142	0.3485

REV NO: A/1 Page :5 of 8





Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level :90%

LTPD:10%

Test Items	Test conditions	Quantity	Judging Criteria
Solderability	Solder Temperature: 240°C Solder Duration: (3.5±0.5) sec.	22	Solderable Area Over 95%
Thermal Shock Followed by High Temperature And High Humidity Cyclic	-40°→10min 5 Cycles ↑ ↓ shift(2~3)min 100°C →10 min. 25°C~55°C (90%~95%) RH 2 Cycles for 48 hrs., Recover for 2 hrs	22	C=0 & **
Resistance For Soldering Heat	Reflow Soldering	22	C=0 & I**
DC Operating Life	1000 hrs. Forward Current: 150mA	22	C=0 & I**
High Temperature Storage	100°C □→ 1000 hrs	22	C=0 & I**
High Temperature And High Humidity Cyclic	25℃~55℃ (90%~95%) RH 6 Cycles for 144 hrs., Recover for 2 hrs.	22	C=0 & I**

The thchnical iformation shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

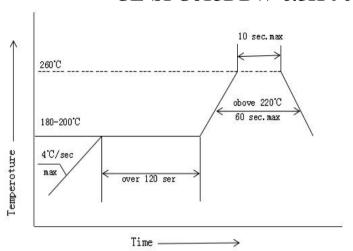
REV NO: A/1 Page 6 of 8





SMT Reflow Soldering Instructions

- 1.Reflow soldering is not can do two times
- 2.When soldering, do not put stress on the LEDs during heating.

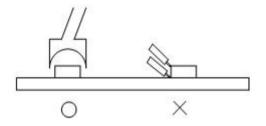


Soldering iron

- 1. When hand soldering, the temperature of the iron must less than 300 °C for 3 seconds
- 2. The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.



Storage

The package is sealed:

- 1.The LEDs Should be store at 5 $^{\circ}$ C ~ 30 $^{\circ}$ C and 90% RH or less.
- 2.It is recommended that SMD out of their original packaging are used within one year.

The package is opened:

- 1.Completed within 168 hours.
- 2.Stored at5 °C~30 °C and 60% RH or less.
- 3.LEDs stored more than 168 hours should be baked at about $60^{\circ}\text{C}\pm5^{\circ}\text{C}$ for at least 20 hours before solder assembly.

Handling Precautions

1.Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicone lens or damage.

2.Not available in the situation of acidity for PH.



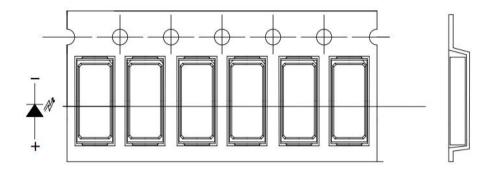


REV NO: A/1 Page: 7 of 8



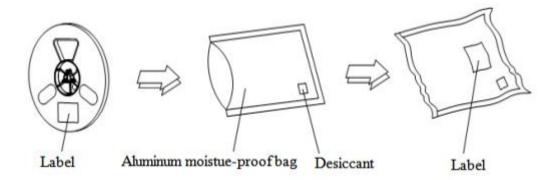


Carrier tape 3000pcs/reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit: mm

Moisture Resistant Packaging



REV NO: A/1 Page :8 of 8